

MiniSKiiP® 2

SKiiP 24AC12T4V1

Features

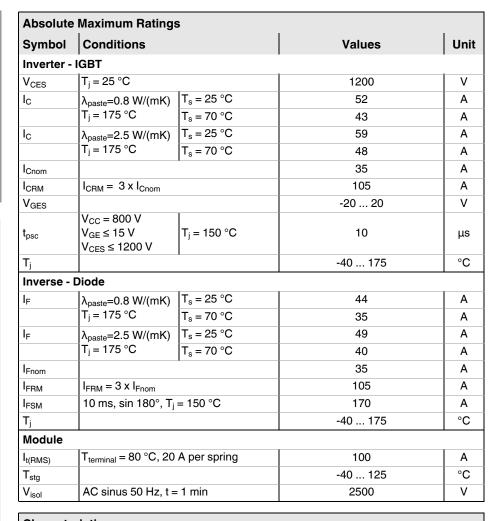
- Trench 4 IGBTs
- Robust and soft freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognised: File no. E63532

Typical Applications*

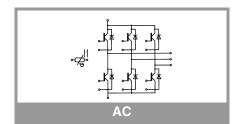
- Inverter up to 22 kVA
- Typical motor power 11 kW

Remarks

- V_{CEsat}, V_F = chip level value
- Case temp. limited to T_C = 125°C max. (for baseplateless modules T_C = T_S)
- product rel. results valid for T_j ≤150 (recomm. T_{op} = -40 ... +150°C)



Characteristics									
Symbol	Conditions	min.	typ.	max.	Unit				
Inverter -	IGBT								
V _{CE(sat)}	$I_{\rm C} = 35 {\rm A}$	T _j = 25 °C		1.85	2.10	V			
	V _{GE} = 15 V chiplevel	T _j = 150 °C		2.25	2.45	V			
V _{CE0}	chiplevel	T _j = 25 °C		0.80	0.90	V			
		T _j = 150 °C		0.70	0.80	V			
r _{CE}	V _{GE} = 15 V chiplevel	T _j = 25 °C		30	34	mΩ			
		T _j = 150 °C		44	47	mΩ			
V _{GE(th)}	$V_{GE} = V_{CE}$, $I_C = 1$ mA		5	5.8	6.5	V			
I _{CES}	$V_{GE} = 0 \text{ V}, V_{CE} = 12$	00 V, T _j = 25 °C		0.1	0.3	mA			
C _{ies}	V _{CE} = 25 V V _{GE} = 0 V	f = 1 MHz		1.95		nF			
Coes		f = 1 MHz		0.16		nF			
C _{res}		f = 1 MHz		0.12		nF			
Q_G	- 8 V+ 15 V			200		nC			
R _{Gint}	T _j = 25 °C			0		Ω			
t _{d(on)}	$V_{CC} = 600 \text{ V}$ $I_{C} = 35 \text{ A}$ $R_{G \text{ on}} = 15 \Omega$ $R_{G \text{ off}} = 15 \Omega$ $di/dt_{on} = 1300 \text{ A/}\mu\text{s}$ $di/dt_{off} = 460 \text{ A/}\mu\text{s}$	T _j = 150 °C		21		ns			
t _r		T _j = 150 °C		31		ns			
E _{on}		T _j = 150 °C		3.7		mJ			
t _{d(off)}		T _j = 150 °C		310		ns			
t _f		T _j = 150 °C		63		ns			
E _{off}	V _{GE} = +15/-15 V	T _j = 150 °C		3		mJ			
R _{th(j-s)}	per IGBT, λ _{paste} =0.8 W/(mK)			0.85		K/W			
R _{th(j-s)}	per IGBT, λ _{paste} =2.5 W/(mK)			0.69		K/W			





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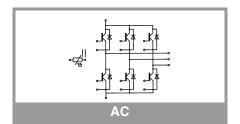
Typical Applications*

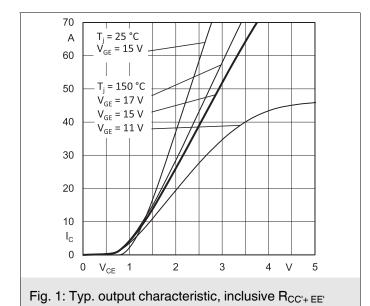
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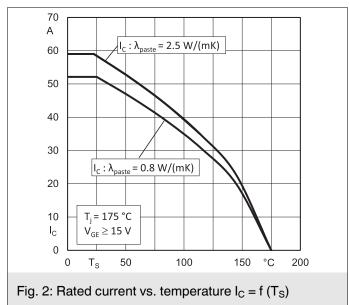
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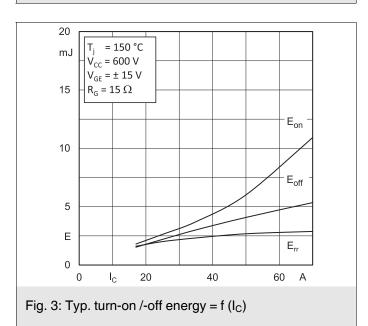
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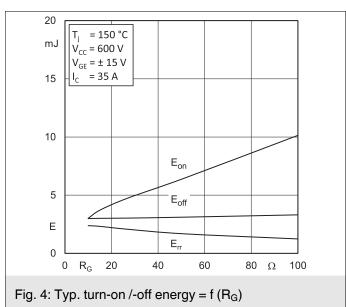
Characteristics											
Symbol	Conditions		min.	typ.	max.	Unit					
Inverse - Diode											
$V_F = V_{EC}$	$I_F = 35 \text{ A}$	T _j = 25 °C		2.30	2.62	V					
V _{GE} = 0 V chiplevel	T _j = 150 °C		2.29	2.62	V						
V _{F0}	chiplevel	T _j = 25 °C		1.30	1.50	V					
		T _j = 150 °C		0.90	1.10	V					
r _F	chiplevel	T _j = 25 °C		29	32	mΩ					
		T _j = 150 °C		40	43	mΩ					
I _{RRM}	$di/dt_{off} = 1400 \text{ A/}\mu\text{s}$ $V_{GE} = +15/-15 \text{ V}$	T _j = 150 °C		38		Α					
Q _{rr}		T _j = 150 °C		6.2		μC					
E _{rr}		T _j = 150 °C		2.3		mJ					
R _{th(j-s)}	per Diode, λ _{paste} =0.8 W/(mK)			1.2		K/W					
R _{th(j-s)}	per Diode, λ _{paste} =2.5 W/(mK)			1		K/W					
Module											
L _{CE}				-		nΗ					
Ms	to heat sink		2		2.5	Nm					
W				55		g					
Temperat	ture Sensor										
R ₁₀₀	T _r =100°C (R ₂₅ =1000Ω)			1670 ± 3%		Ω					
R(T)	R(T)=1000 Ω [1+A(T-25°C)+B(T-25°C) ²], A = 7.635*10 ⁻³ °C ⁻¹ , B = 1.731*10 ⁻⁵ °C ⁻²										

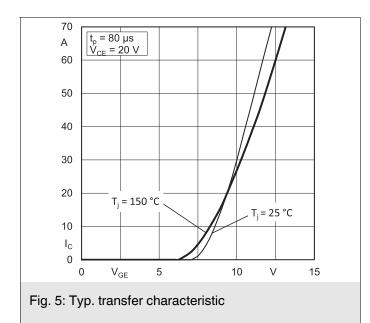


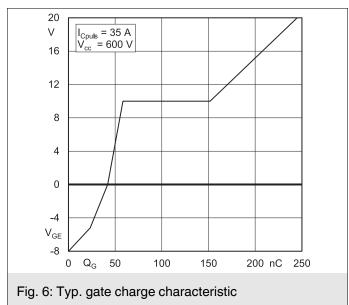












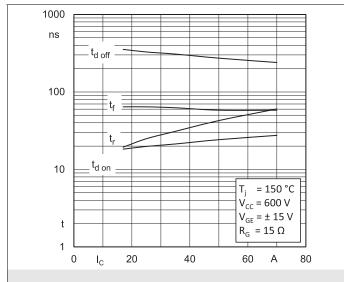


Fig. 7: Typ. switching times vs. I_C

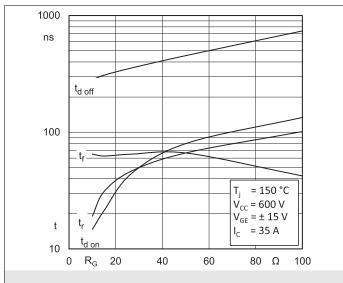


Fig. 8: Typ. switching times vs. gate resistor R_{G}

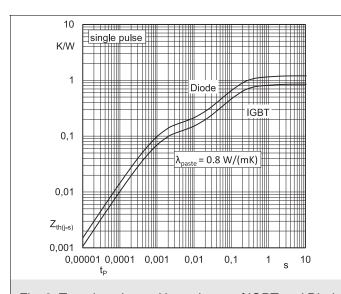


Fig. 9: Transient thermal impedance of IGBT and Diode

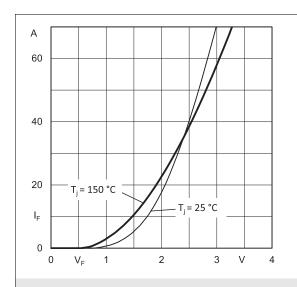


Fig. 10: CAL diode forward characteristic

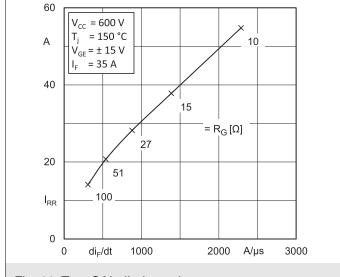


Fig. 11: Typ. CAL diode peak reverse recovery current

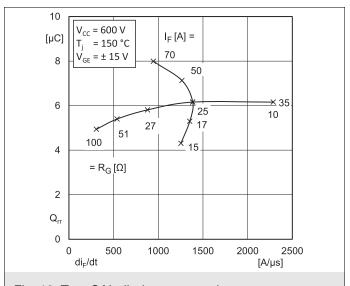
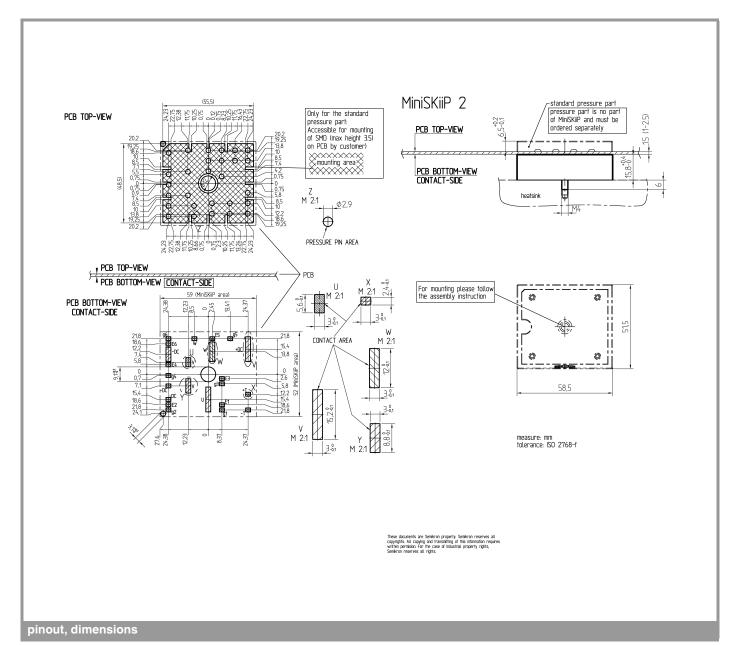
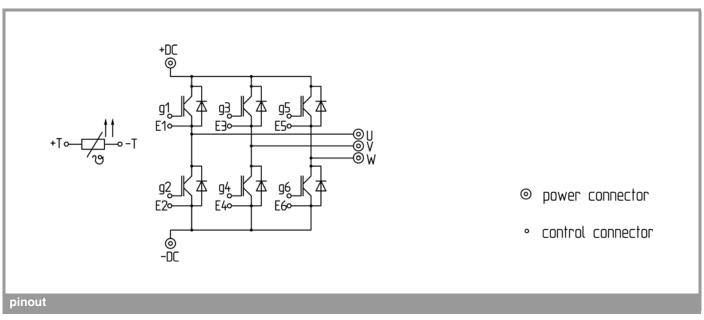


Fig. 12: Typ. CAL diode recovery charge





This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

*IMPORTANT INFORMATION AND WARNINGS

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FD400R12KE3 FD400R33KF2C-K FD401R17KF6C_B2 FD-DF80R12W1H3_B52 FF100R12KS4 FF1200R17KE3_B2 FF150R12KE3G

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FF300R12KS4HOSA1 FF300R12ME4_B11 FF300R12MS4 FF300R17ME4 FF450R12ME4P FF450R17IE4 FF600R12IE4V

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FP100R07N3E4_B11 FP10R06W1E3_B11 FP10R12W1T4_B11 FP10R12YT3 FP10R12YT3_B4 FP150R07N3E4 FP15R12KT3

FP15R12W2T4